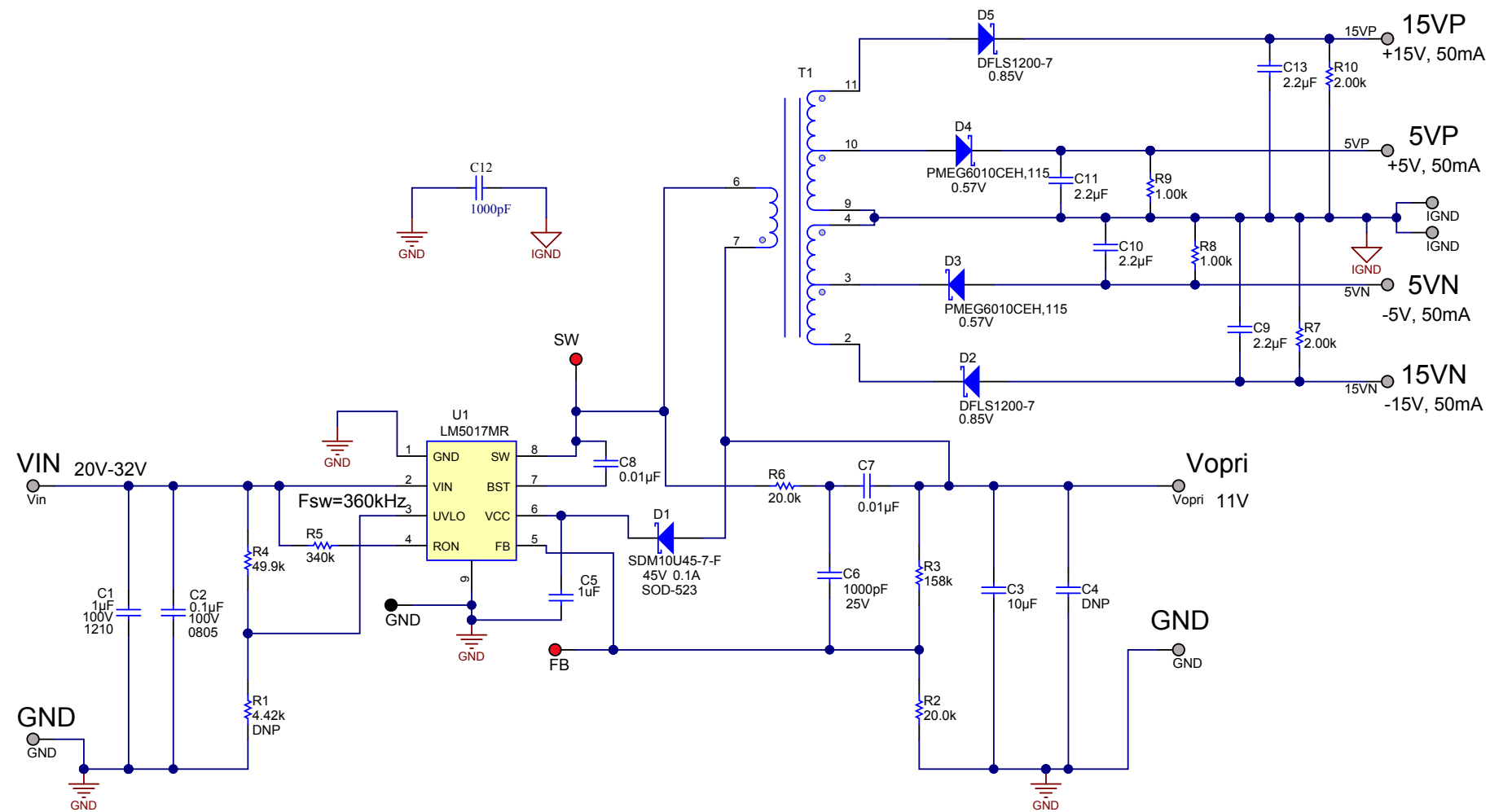


Quad_Output Flybuck



A

A

PCB
LOGO
Texas Instruments

PCB Number: PMP9478
PCB Rev: 3

LBL1



FID2



FID3



FID1

ZZ4

Label Assembly Note

This Assembly Note is for PCB labels only

ZZ3

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ1

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

B

B

C

C

D

D

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Designed for: Public Release		Mod. Date: 3/11/2014	
Project Title: PMP9478			
Number: PMP9478	Rev: 3	Sheet Title:	
SVN Rev: Not in version control		Assembly Variant: [No Variations]	Sheet: 1 of 1
Drawn By:		File: Flybuck_Lowpro_Quad_Hardware.SchDoc	Size: B
Engineer: X Fang		Contact: http://www.ti.com/support	



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